Octal D-type flip-flop; positive edge-trigger; 3-state Rev. 02 — 24 January 2008 Produc

Product data sheet

General description 1.

The 74AHC574; 74AHCT574 are high-speed Si-gate CMOS devices and are pin compatible with Low Power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC574; 74AHCT574 are octal D-type flip-flops featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A clock (CP) and an output enable (\overline{OE}) input are common to all flip-flops.

The 8 flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When \overline{OE} is LOW the contents of the 8 flip-flops are available at the outputs. When \overline{OE} is HIGH, the outputs go to the high-impedance OFF-state. Operation of the OE input does not affect the state of the flip-flops.

The 74AHC574; 74AHCT574 is functionally identical to the 74AHC564; 74AHCT564, but has non-inverting outputs. The 74AHC574; 74AHCT574 is functionally identical to the 74AHC374; 74AHCT374, but has a different pinning.

Features 2.

- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- 3-state non-inverting outputs for bus orientated applications
- 8-bit positive, edge-triggered register
- Independent register and 3-state buffer operation
- Common 3-state output enable input
- For 74AHC574 only: operates with CMOS input levels
- For 74AHCT574 only: operates with TTL input levels
- ESD protection:
 - HBM JESD22-A114E exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

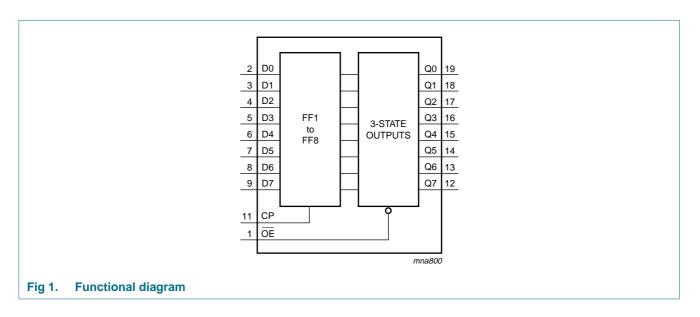
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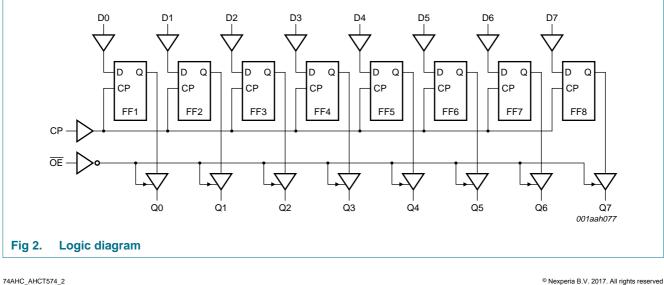
Octal D-type flip-flop; positive edge-trigger; 3-state

3. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC574D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74AHCT574D			body width 7.5 mm	
74AHC574PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1
74AHCT574PW			body width 4.4 mm	
74AHC574BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced	SOT764-1
74AHCT574BQ			very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	

4. Functional diagram

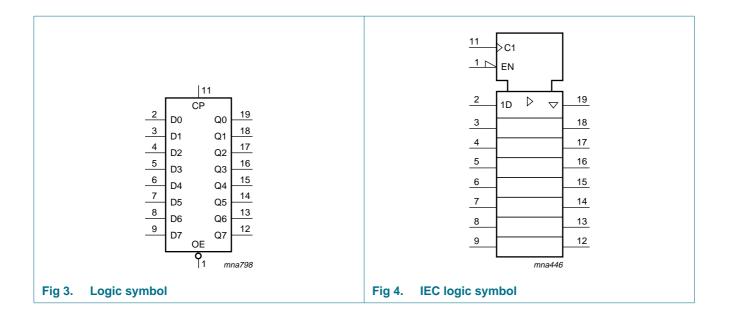




Product data sheet

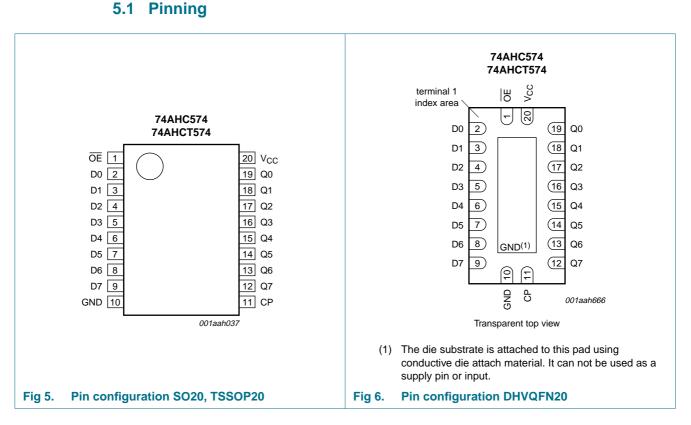
74AHC574; 74AHCT574

Octal D-type flip-flop; positive edge-trigger; 3-state



Octal D-type flip-flop; positive edge-trigger; 3-state

5. Pinning information



5.2 Pin description

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Table 2.	Pin description	
Symbol	Pin	Description
ŌĒ	1	3-state output enable input (active LOW)
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
СР	11	clock input (LOW-to-HIGH, edge triggered)
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	3-state flip-flop output
V _{CC}	20	supply voltage

Octal D-type flip-flop; positive edge-trigger; 3-state

6. Functional description

Table 3.Function table

Operating mode	Input			Internal	Output
	OE	СР	Dn	flip-flop	Qn
Load and read register	L	\uparrow	I	L	L
	L	\uparrow	h	Н	Н
Load register and disable output	Н	\uparrow	I	L	Z
	Н	\uparrow	h	Н	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one setup time prior to the HIGH-to-LOW CP transition;

L = LOW voltage level;

I = LOW voltage level one setup time prior to the HIGH-to-LOW CP transition;

Z = high-impedance OFF-state;

 \uparrow = LOW-to-HIGH clock transition.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage		-0.5	+7.0	V
l _{IK}	input clamping current	V _I < -0.5 V	[1] -20	-	mA
l _{ок}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
lo	output current	$V_{\rm O}$ = -0.5 V to (V_{\rm CC} + 0.5 V)	-	±25	mA
I _{CC}	supply current		-	75	mA
I _{GND}	ground current		-75	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$			
	SO20 package		[2] _	500	mW
	TSSOP20 package		[3] _	500	mW
	DHVQFN20 package		[4]	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] P_{tot} derates linearly with 8 mW/K above 70 °C.

[3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[4] P_{tot} derates linearly with 4.5 mW/K above 60 °C.

Octal D-type flip-flop; positive edge-trigger; 3-state

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	7	4AHC57	4	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise	V_{CC} = 3.3 V \pm 0.3 V	-	-	100	-	-	-	ns/V
	and fall rate	$V_{CC}=5.0~V\pm0.5~V$	-	-	20	-	-	20	ns/V

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		−40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
For type	74AHC574									
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
VIL	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 3.0 \ \text{V}$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_0 = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_0 = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 50 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I_{O} = 8.0 mA; V_{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I _{OZ}	OFF-state output current		-	-	±0.25	-	±2.5	-	±10.0	μΑ
I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
сс	supply current		-	-	4.0	-	40	-	80	μA
4AHC_AHCT57	74_2							© Nexpe	ria B.V. 2017. All rig	hts reserv

Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions		25 °C		–40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
Cı	input capacitance		-	3.0	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF
For type	74AHCT574									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = –50 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.8	-	3.70	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 50 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
I _{OZ}	OFF-state output current	per input pin; $V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5 V$; $I_O = 0 A$; $V_O = V_{CC}$ or GND; other pins at V_{CC} or GND	-	-	±0.25	-	±2.5	-	±10.0	μA
lı	input leakage current	$V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current		-	-	4.0	-	40	-	80	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
CI	input capacitance		-	3	10	-	10	-	10	pF
Co	output capacitance		-	4.0	-	-	-	-	-	pF

Octal D-type flip-flop; positive edge-trigger; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V. For test circuit see Figure 10.

Symbol	Parameter	Conditions			25 °C		_40 °C	to +85 °C	−40 °C t	to +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
For type	74AHC574										
t _{pd}	propagation	CP to Qn; see Figure 7	[2]								
	delay	V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	6.5	13.2	1.0	15.5	1.0	16.5	ns
		$C_L = 50 \text{ pF}$		-	9.3	16.7	1.0	19.0	1.0	21.0	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.4	8.6	1.0	10.0	1.0	11.0	ns
		$C_L = 50 \text{ pF}$			6.2	10.6	1.0	12.0	1.0	13.5	ns
t _{en}	enable time	OE to Qn; see Figure 9	<u>[1]</u>								
		V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	5.7	12.8	1.0	15.0	1.0	16.0	ns
		$C_L = 50 \text{ pF}$		-	8.2	16.3	1.0	18.5	1.0	20.5	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.2	9.0	1.0	10.5	1.0	11.5	ns
		C _L = 50 pF		-	5.9	11.0	1.0	12.5	1.0	14.0	ns
t _{dis}	disable time	OE to Qn; see Figure 9	[2]								
		V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	6.3	13.0	1.0	15.0	1.0	16.5	ns
		C _L = 50 pF		-	9.1	15.0	1.0	17.0	1.0	19.0	ns
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C _L = 50 pF		-	6.9	10.1	1.0	11.5	1.0	13.0	ns
f _{max}	maximum	CP; see Figure 7									
	frequency	V_{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		80	125	-	65	-	65	-	MHz
		C _L = 50 pF		50	75	-	45	-	45	-	MHz
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		130	180	-	110	-	110	-	MHz
		C _L = 50 pF		85	115	-	75	-	75	-	MHz
t _W	pulse width	CP; HIGH or LOW; see <u>Figure 7</u>									
		V_{CC} = 3.0 V to 3.6 V; C_{L} = 50 pF		5.0	-	-	5.0	-	5.0	-	ns
		V_{CC} = 4.5 V to 5.5 V; C_{L} = 50 pF		5.0	-	-	5.0	-	5.0	-	ns

Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions			25 °C		−40 °C	to +85 °C	–40 °C t	o +125 °C	Uni
				Min	Typ[1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	Dn to CP; see Figure 8									
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $C_L = 50 \text{ pF}$		3.5	-	-	3.5	-	3.5	-	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V;$ $C_L = 50 \text{ pF}$		3.0	-	-	3.0	-	3.0	-	ns
t _h	hold time	Dn to CP; see Figure 8									
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $C_{L} = 50 \text{ pF}$		1.5	-	-	1.5	-	1.5	-	ns
		$V_{CC} = 4.5 V \text{ to } 5.5 V;$ $C_{L} = 50 \text{ pF}$		1.5	-	-	1.5	-	1.5	-	ns
C _{PD}	power dissipation capacitance	C_L = 50 pF; f _i = 1 MHz; V _I = GND to V _{CC}	[3]	-	10	-	-	-	-	-	pF
For type	74AHCT574										
t _{pd}	propagation	CP to Qn; see Figure 7	[2]								
	delay	V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.4	8.6	1.0	10.0	1.0	11.0	ns
		C _L = 50 pF		-	6.3	10.6	1.0	12.0	1.0	13.5	ns
t _{en}	enable time	OE to Qn; see Figure 9									
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C _L = 50 pF		-	6.1	11.0	1.0	12.5	1.0	14.0	ns
t _{dis}	disable time	OE to Qn; see Figure 9	[2]								
		V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	4.3	9.0	1.0	10.5	1.0	11.5	ns
		C _L = 50 pF		-	6.2	10.1	1.0	11.5	1.0	13.0	ns
f _{max}	maximum	CP; see Figure 7									
	frequency	V_{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		130	180	-	110	-	110	-	MH
		C _L = 50 pF		85	115	-	75	-	75	-	MH
t _W	pulse width	CP; HIGH or LOW; see <u>Figure 7</u>									
		V_{CC} = 4.5 V to 5.5 V; C_L = 50 pF		5.0	-	-	5.5	-	5.5	-	ns
t _{su}	set-up time	Dn to CP; see Figure 8									
		$V_{CC} = 4.5 V$ to 5.5 V; $C_{L} = 50 \text{ pF}$		3.0	-	-	3.5	-	3.5	-	ns

Table 7. Dynamic characteristics ... continued GND = 0 V. For test circuit see Figure 10.

74AHC_AHCT574_2

Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state

Symbol	Parameter	Conditions	25 °C			–40 °C to +85 °C		–40 °C to +125 °C		Unit	
				Min	Typ[1]	Max	Min	Max	Min	Max	
t _h	hold time	Dn to CP; see Figure 8						•			
		V_{CC} = 4.5 V to 5.5 V; C_L = 50 pF		1.5	-	-	1.5	-	1.5	-	ns
C _{PD}	power dissipation capacitance	per buffer; $C_L = 50 \text{ pF}; f = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	<u>[3]</u>	-	12	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

[1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V).

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

- [3] C_{PD} is used to determine the dynamic power dissipation P_D (μW).
 - $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

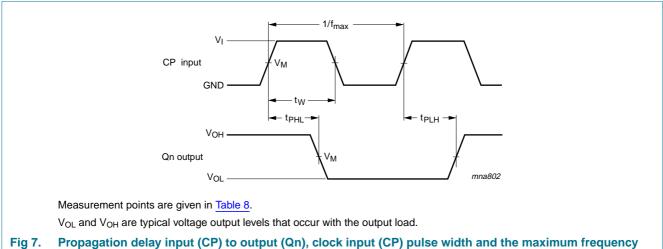
 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

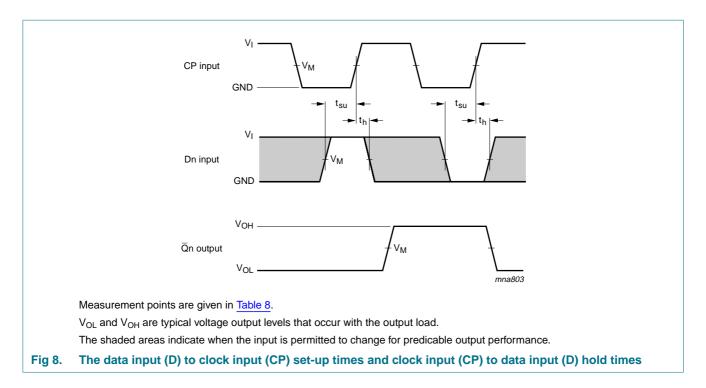
 V_{CC} = supply voltage in V.

10.1 Waveforms



74AHC574; 74AHCT574

Octal D-type flip-flop; positive edge-trigger; 3-state



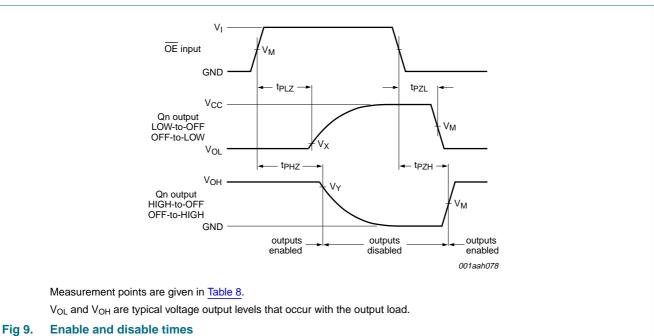


Table 8. Measurement points

Туре	Input	Output		
	V _M	V _M	V _X	V _Y
74AHC574	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} – 0.3 V
74AHCT574	1.5 V	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} – 0.3 V

74AHC_AHCT574_2

Product data sheet

74AHC574; 74AHCT574

Octal D-type flip-flop; positive edge-trigger; 3-state

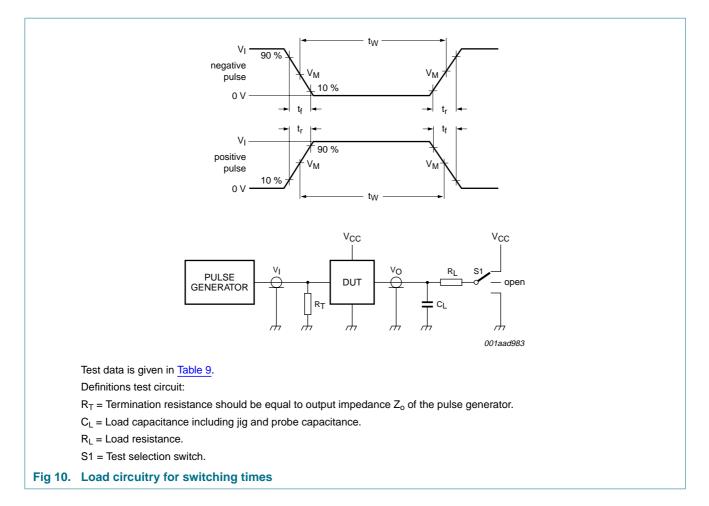


Table 9. Test data

Туре	Input Load			S1 position				
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
74AHC574	V _{CC}	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	
74AHCT574	3.0 V	3.0 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}	

Octal D-type flip-flop; positive edge-trigger; 3-state

11. Package outline

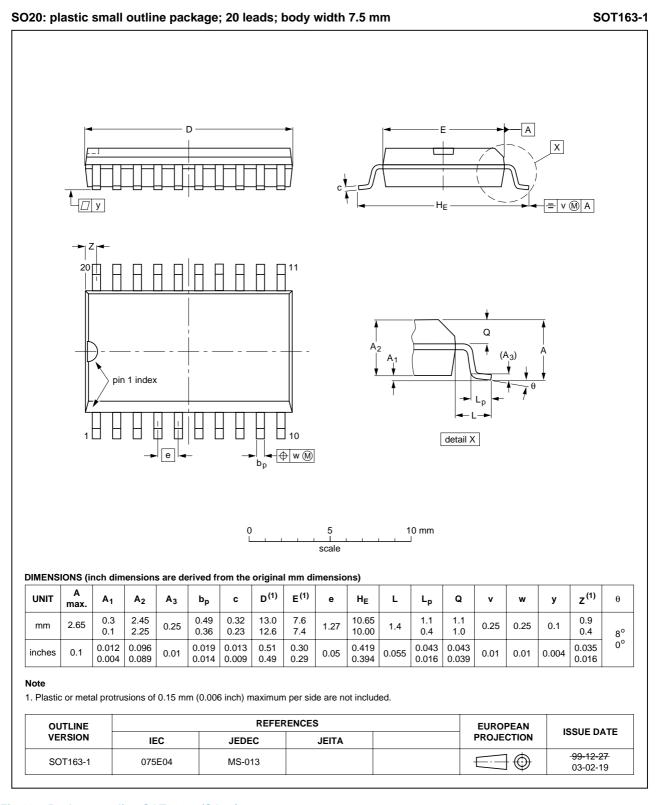


Fig 11. Package outline SOT163-1 (SO20)

74AHC_AHCT574_2

Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state

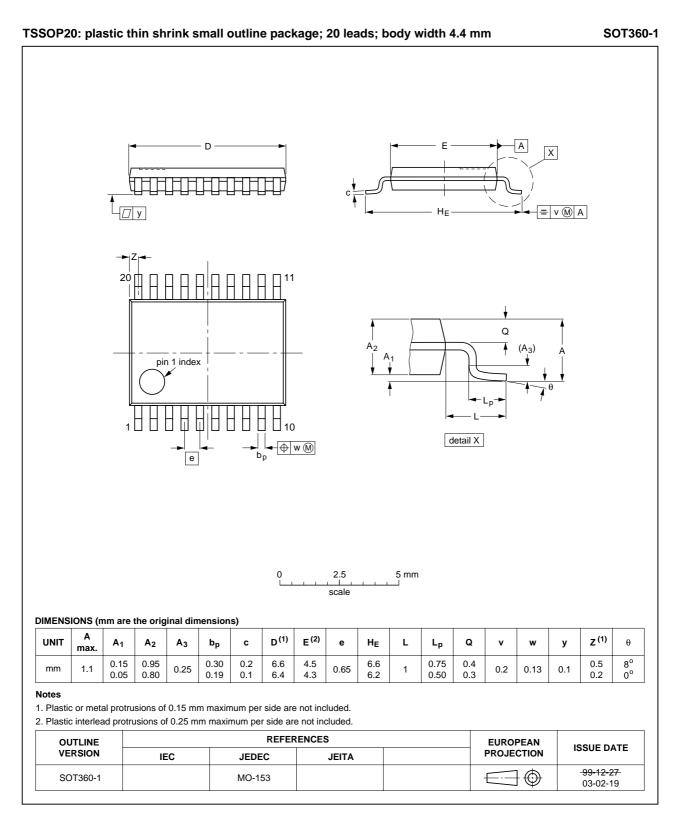
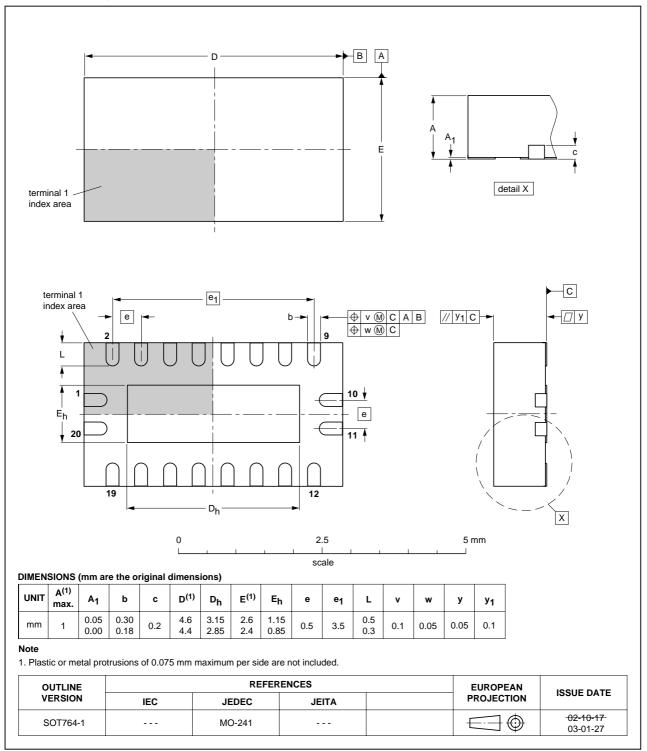


Fig 12. Package outline SOT360-1 (TSSOP20)

74AHC_AHCT574_2

Product data sheet

Octal D-type flip-flop; positive edge-trigger; 3-state



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 13. Package outline SOT764-1 (DHVQFN20)

74AHC_AHCT574_2

Product data sheet



Octal D-type flip-flop; positive edge-trigger; 3-state

12. Abbreviations

Table 10.	Abbreviations		
Acronym	Description		
CDM	Charged-Device Model		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

13. Revision history

Table 11. Revision history						
Release date	Data sheet status	Change notice	Supersedes			
20080124	Product data sheet	-	74AHC_AHCT574_1			
 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
 Legal texts have been adapted to the new company name where appropriate. 						
 <u>Section 3</u>: DH' 	VQFN20 package added.					
 <u>Section 7</u>: derating values added for DHVQFN20 package. 						
 Section 11: ou 	Itline drawing added for DF	IVQFN20 package.				
19990616	Product specification	-	-			
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Octal D-type flip-flop; positive edge-trigger; 3-state

14. Legal information

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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Octal D-type flip-flop; positive edge-trigger; 3-state

16. Contents

1	General description 1
2	Features 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 4
6	Functional description 5
7	Limiting values5
8	Recommended operating conditions 6
9	Static characteristics 6
10	Dynamic characteristics 8
10.1	Waveforms 10
11	Package outline 13
12	Abbreviations 16
13	Revision history 16
14	Legal information 17
14.1	Data sheet status 17
14.2	Definitions 17
14.3	Disclaimers
14.4	Trademarks 17
15	Contact information 17
16	Contents 18

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